Surface Mount Fast Recovery Rectifiers

Reverse Voltage - 1000 V

Forward Current - 10 A

FEATURES

- · For surface mounted applications
- · Low profile package
- Glass Passivated Chip Junction
- · Easy to pick and place
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

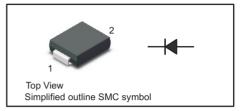
· Case: SMC

• Terminals: Solderable per MIL-STD-750, Method 2026

Approx. Weight: 0.22g / 0.0077oz

PINNING

PIN	DESCRIPTION	
1	Cathode	
2	Anode	



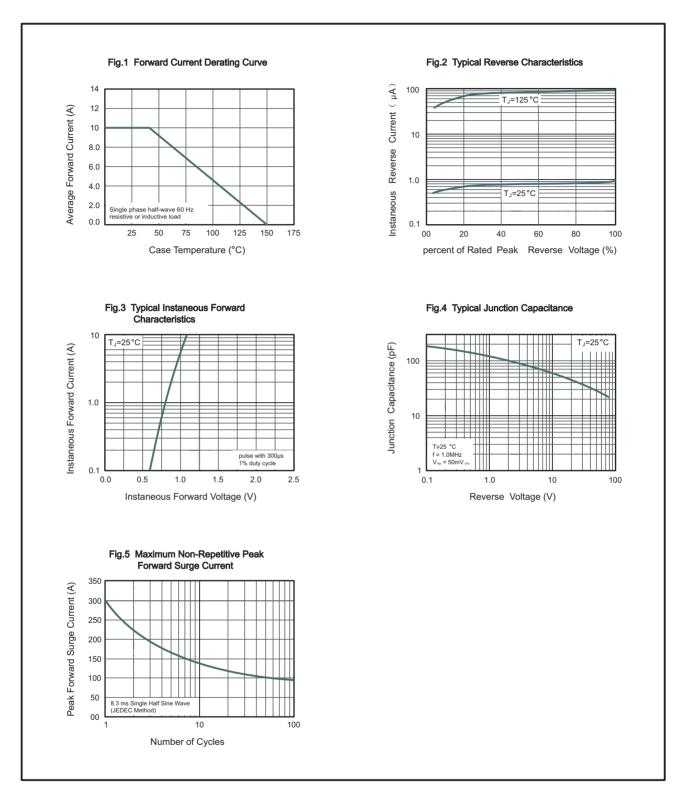
Absolute Maximum Ratings and Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	RS10MC	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	1000	V
Maximum RMS voltage	V_{RMS}	700	V
Maximum DC Blocking Voltage	$V_{ extsf{DC}}$	1000	V
Maximum Average Forward Rectified Current @ Fig.1	I _{F(AV)}	10	Α
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	300	А
Peak Forward Surge Current 1.0 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	600	А
I²t Rating for fusing (3ms≤t≤8.3ms)	l ² t	373	A ² S
Maximum Forward Voltage at 10 A	V _F	1.3	٧
	I _R	10 100	μА
Typical Junction Capacitance at V _R =4V, f=1MHz	C _j	80	pF
Maximum Reverse Recovery Time (1)	t _{rr}	500	ns
Typical Thermal Resistance (2)	$R_{ heta_{JA}} \ R_{ heta_{JC}} \ R_{ heta_{JL}}$	37 10 13	°C/W
Operating and Storage Temperature Range	T_{j},T_{stg}	-55 ~ +150	°C

⁽¹⁾ Measured with $I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{\pi} = 0.25 \text{ A}$.

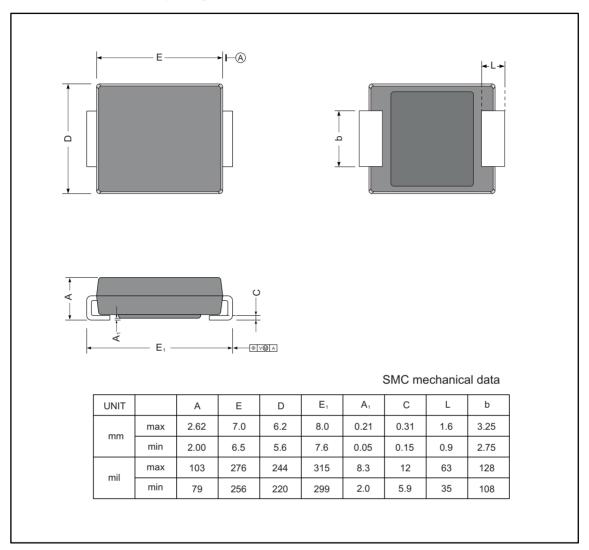
⁽²⁾ P.C.B. mounted with 1.5" X 1.5" (3.81 X 3.81 cm) copper pad areas.



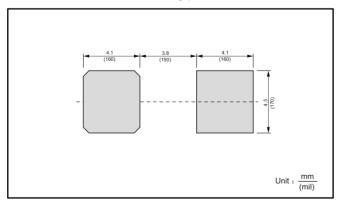
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMC



The recommended mounting pad size



Marking

Type number	Marking code
RS10MC	RS10M

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